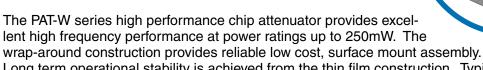
High Frequency Surface Mount Attenuators



PAT-W

- 10GHz operation
- ±50ppm/°C absolute TCR
- 50 impedance available in 2 chip sizes available
- Wrap-around 90/10 Sn/Pb or 100% Sn terminations



Long term operational stability is achieved from the thin film construction. Typical uses include applications in medical, industrial, and communications.

Electrical Data

	PAT3042	PAT4556	
Impedance	50		
TCR	±50ppm/°C		
Attenuation (dB)	0, 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 16, 20		
Power Rating @ 70°C	250mW	500mW	
VSWR	DC to 2GHz = 1.1 2GHz to 5GHz = 1.2 5GHz to 10GHz = 1.3		
Operating Temperature Range	-55°C to +125°C		
	90/10 Sn/Pb		
Terminations	0 100%	•	

Attenuation Tolerance Data

Attenuation Value	Attenuation Tolerance Code	DC to 2GHz	2GHz to 5GHz	5GHz to 10GHz
0dB	Α	+0.1/ -0dB	+0.2/ -0dB	+0.4/ -0dB
1 to 10dB	А	±0.1dB	±0.2dB	±0.4dB
T to Todb	В	±0.2dB	±0.3dB	±0.5dB
16, 20dB	В	±0.2dB	±0.3dB	±0.5dB

Environmental Data

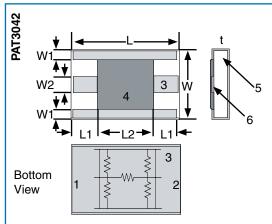
	Test Condition	Attenuation		Impadance
	rest Condition	0 to 10dB	16, 20dB	Impedance
Short Time Over Load	2.5 x Rated Voltage, 5 sec	±0.01dB	±0.02dB	±0.2%
Load Life	1000 Hours, 70°C	±0.02dB	±0.04dB	±0.5%
Moisture Resistance	1000 hours, 60°C, 95% RH	±0.02dB	±0.04dB	±0.5%
Temperature Cycle	5 Cycles, 125°C High, -55°C Low	±0.01dB	±0.02dB	±0.2%
Resistance to Solder Heat	260°C, 10 sec.	±0.01dB	±0.02dB	±0.2%
Solderability	235°C, 3 sec	>95% coverage		
Insulation Resistance	500V, 1 minute	>1000M		



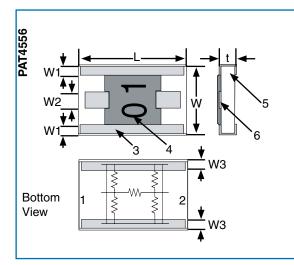
High Frequency Surface Mount Attenuators



Physical Data



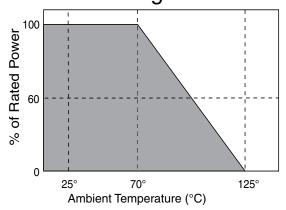
Dimensions (mm)						
	0dB	1dB	2 to 3dB	4 to 6dB	7 to 10dB	16, 20dB
L2	4.20 ±0.20	0.30 ±0.20		0.60 ±0.20	0.90 ±0.20	1.80 ±0.20
L1		1.90 ±0.20		1.75 ±0.20	1.60	±0.20
W1	0.30 ±0.	0.30 ±0.15		0.40 ±0.15		
W2	0.85 ±0.10		0.65 ±0.1			
L	4.20 ±0.20					
w	3.02 ±0.20					
t	0.80 ±0.15					



Dimensions (mm)			
	0dB 1to10dB, 16dB, 20dB		
W1	0.06 ±0.10	0.40 ±0.15	
W2	0.64 ±0.10	1.3 ±0.1	
W3	0.60 ±0.10		
L	5.60 ±0.20		
w	4.50 ±0.20		
t	0.80 ±0.15		

^{1, 2:} Input and output terminals 3: Electrode (surface soldering and lead-free possible) 4: Covering resin 5: Alumina substrate 6: Thin film resistor

Power Derating Curve



Ordering Data

